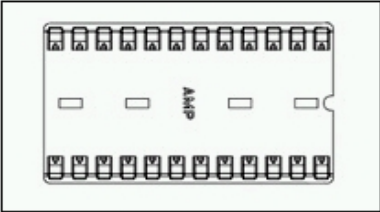


2-641266-3 Product Details



2-641266-3

DIP Sockets

[Not reviewed for RoHS Compliance](#)

Product Highlights:

- Socket Style = Standard
- Through Hole Contact Termination Type
- 2.54 mm Centerline
- Row-to-Row Spacing = 7.87 mm
- 24 Positions

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TE Internal Number: 2-641266-3



Superseded



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Documentation & Additional Information	
Product Drawings: • SOCKET ASSY, DIP, RET LEG, 24 POS, DIPLOMATE DL - (PDF, English) Catalog Pages/Data Sheets: • None Available Product Specifications: • None Available Application Specifications: • None Available Instruction Sheets: • None Available CAD Files: • None Available	Additional Information: • Product Line Information Related Products: • Tooling
List all Documents	

Product Features (Please use the Product Drawing for all design activity)	
Product Type Features: • Socket Style = Standard • Profile = Standard • Frame Style = Closed • Leg Style = Retention • Proprietary Name = DIPLOMATE DL • Color = Black • Qty./Tube = 17 • Qty. Tubes/Box = 100 • Product Series = Standard Electrical Characteristics: • Insulation Resistance (MΩ) = 10,000 • Contact Resistance (mΩ) = 30 Termination Related Features: • Termination Post Length (mm [in]) = 3.05 [0.120] Body Related Features: • Centerline (mm [in]) = 2.54 [0.100] • Row-to-Row Spacing (mm [in]) = 7.87 [0.310] • Number of Positions = 24 • Mount Style = Vertical Contact Related Features: • Contact Termination Type = Through Hole • Contact Base Material = Phosphor Bronze • Contact Plating, Mating Area, Material = Tin • Contact Style = Stamped + Formed • Mating Contact Type = Dual Leaf	Housing Related Features: • Housing Material = Thermoplastic - GF • UL Flammability Rating = UL 94V-0 Configuration Related Features: • Height Above PC Board (mm [in]) = 5.33 [0.210] Industry Standards: • RoHS/ELV Compliance = Not reviewed for ELV/RoHS compliance • Lead Free Solder Processes = Not reviewed for lead free solder process Conditions for Usage: • Temperature Range (°C) = 105 Operation/Application: • Application = Production Packaging Related Features: • Packaging Method = Tube Other: • Brand = AMP • Comment = ONLY sockets with straight solder tails are recommended for automatic insertion.

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